

RF360 Europe GmbH
A Qualcomm – TDK Joint Venture

Data sheet

SAW duplexer LTE band 71

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Ordering code: B39661B1237L210

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Please read **Cautions and warnings** and **Important notes** at the end of this document.

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1 Application

■ Duplexer for LTE band 71

2 Features

- Package size 2.5±0.1 mm × 2.0±0.1 mm
- Package height 0.7 mm (max.)
- Approximate weight 9 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)

3 Package

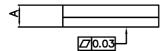
BOTTOM VIEW 0.4 (8x) (0.1) 1 2 3 (8x) CO (0.1) 0.95 0.95

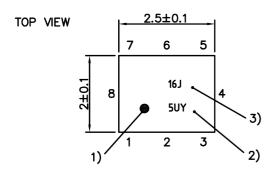
Pad and Pitch Tolerance ±0.05

4 Pin configuration

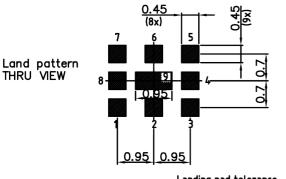
- 1 RX
- 3 TX
- 6 ANT
- 2, 4, 5, 7, Ground 8, 9

SIDE VIEW





- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



Landing pad tolerance -0.02

Figure 1: Drawing of package with package height A = 0.7 mm (max.). See Sec. Package information (p. 24).

5 Matching circuit

■ L_{p6} = 16 nH

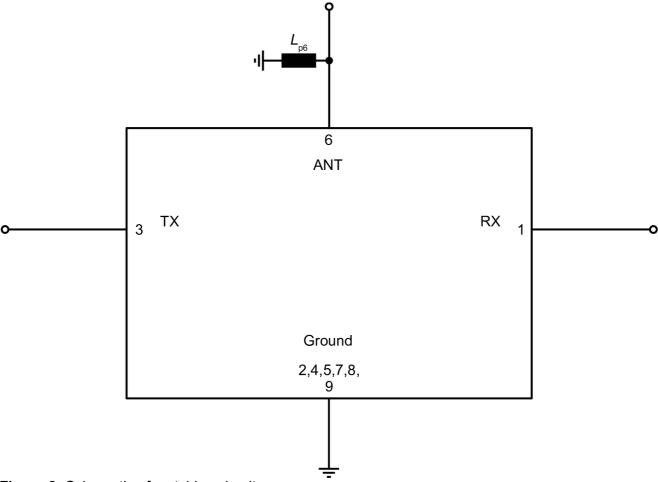


Figure 2: Schematic of matching circuit.

External shunt inductor for ESD protection is recommended at any ports towards antenna.

6 Characteristics

6.1 TX - ANT

Temperature range for specification $T_{\text{SPEC}} = -30 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{Tx} = 50 \Omega$

ANT terminating impedance $Z_{ANT} = 50 \Omega$ with par. 16 nH¹⁾

RX terminating impedance $Z_{RX} = 50 \Omega$

Characteristics TX – ANT				$\begin{array}{c c} \mathbf{min.} \\ \mathbf{for} \ T_{\mathtt{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f _C	_	680.5	_	MHz
Maximum insertion attenuation							
	663 698	MHz	$\alpha_{\text{INT,max}}^{\qquad 2)}$	_	1.5	2.2	dB
	663.34 697.66	MHz	$\boldsymbol{\alpha}_{\text{max}}$	_	2.0	2.73)	dB
	663.34 697.66	MHz	α_{max}	_	2.0	3.0	dB
Amplitude ripple (p-p)			$\Delta \alpha^{4)}$				
	663.34 697.66	MHz		_	0.9	2.0	dB
Maximum VSWR			$VSWR_{max}$				
@ TX port	663.34 697.66	MHz		_	1.2	2.0	
@ ANT port	663.34 697.66	MHz		_	1.4	2.0	
Minimum attenuation			$\alpha_{_{min}}$				
	10 608	MHz		30	47	_	dB
	608 614	MHz		50	57	_	dB
	617.34 651.66	MHz		48	60	_	dB
	717 728	MHz		205)	25	<u> </u>	dB
	717 728	MHz		15	25	<u> </u>	dB
	722 729	MHz		10	43	_	dB
	729 746	MHz		45	67	_	dB
	746 768	MHz		45	52	_	dB
	768 805	MHz		40	52	_	dB
	824 849	MHz		30	36	_	dB
	859 894	MHz		40	48	<u> </u>	dB
	1164 1250	MHz		40	50	_	dB
	1326 1396	MHz		30	49	_	dB
	1559 1563	MHz		45	57	_	dB
	1565.42 1573.374	MHz		45	57	_	dB
	1573.374 1577.644	MHz		45	58	_	dB
	1577.644 1585.42			45	58	_	dB
	1597.551 1605.886			45	59	_	dB
	1710 1755	MHz		30	59	_	dB
	1805 1880	MHz		30	55	_	dB
	1930 1990	MHz		45	55	_	dB
	1989 2094	MHz		45	57	_	dB
	2110 2200	MHz		40	61	_	dB



Characteristics TX – ANT		$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
2400 2484	MHz	35	68	_	dB
2652 2792	MHz	30	63	_	dB
4900 5950	MHz	15	26	_	dB

¹⁾

See Sec. Matching circuit (p. 6). Integrated attenuation α_{INT} : Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels. 2)

³⁾ Valid for typical temperature T = +25 °C.

⁴⁾ Over any 5 MHz.

Valid for temperature $T = +25 \,^{\circ}\text{C...} + 85 \,^{\circ}\text{C.}$



6.2 ANT - RX

Temperature range for specification $T_{\text{SPEC}} = -30 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{TX} = 50 \Omega$

ANT terminating impedance $Z_{ANT} = 50 \Omega$ with par. 16 nH¹⁾

RX terminating impedance $Z_{RX} = 50 \Omega$

Characteristics ANT – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Center frequency			f _C	—	634.5	—	MHz
Maximum insertion attenuation							
	617 652	MHz	$\alpha_{\text{INT,max}}^{\qquad 2)}$	_	1.6	2.3	dB
	617.34 651.66	MHz	α_{max}	_	2.0	2.73)	dB
	617.34 651.66	MHz	α _{max}	_	2.0	3.3	dB
Amplitude ripple (p-p)			$\Delta \alpha^{4)}$				
	617.34 651.66	MHz		_	0.8	2.5	dB
Maximum VSWR			VSWR _{max}				
@ ANT port	617.34 651.66	MHz	IIIdA	_	1.5	2.0	
@ RX port	617.34 651.66	MHz		_	1.5	2.0	
Average attenuation			$\boldsymbol{\alpha}_{avg}$				
	1.0 602	MHz	u.9	30 ⁵⁾	37 ⁵⁾	_	dB
	602 608	MHz		13 ⁶⁾	35 ⁶⁾	_	dB
	608 614	MHz		2 ⁶⁾	5 ⁶⁾	_	dB
	657.56 662.44	MHz		11 ⁷⁾	25 ⁷⁾	_	dB
Minimum attenuation			$\alpha_{_{min}}$				
	35 55	MHz		50	70	_	dB
	663.34 697.66	MHz		45	56	_	dB
	709 740	MHz		20	41	_	dB
	776 793	MHz		35	39	_	dB
	793 805	MHz		35	39	_	dB
	824 849	MHz		35	40	_	dB
	1058 1138	MHz		25	42	_	dB
	1163 1204	MHz		35	41	_	dB
	1233 1281	MHz		35	40	_	dB
	1461 1484	MHz		35	56	_	dB
	1653 1698	MHz		25	45	_	dB
	1710 1755	MHz		40	45	_	dB
	1850 1920	MHz		40	47	_	dB
	1851 1956	MHz		40	47	_	dB
	2305 2315	MHz		20	43	_	dB
	2327 2407	MHz		20	43	_	dB
	2400 2500	MHz		37	42	_	dB
	2468 2608	MHz		20	42	_	dB
	2922 2967	MHz		20	40	_	dB



Characteristics ANT – RX			typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
4037 416	2 MHz	20	29	_	dB
4317 447	2 MHz	15	22	_	dB
4900 5950	0 MHz	10	18	_	dB

See Sec. Matching circuit (p. 6).

Integrated attenuation $\alpha_{|NT|}$: Averaged power $|S_{ij}|^2$ over the center 4.5 MHz of LTE 5 MHz (25 RB) channels.

³⁾ Valid for typical temperature T = +25 °C.

⁴⁾ Over any 5 MHz.

⁵⁾ Over any channel with band width of 6MHz.

⁶⁾ Over 6MHz channel.

Over any channel with band width of 4.875MHz.



6.3 TX - RX

Temperature range for specification $T_{\text{SPEC}} = -30 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

TX terminating impedance $Z_{TY} = 50 \Omega$

ANT terminating impedance $Z_{ANT} = 50 \Omega$ with par. 16 nH¹⁾

RX terminating impedance $Z_{RX} = 50 \Omega$

Characteristics TX – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Minimum isolation			$\alpha_{_{min}}$				
	617.34 651.66	MHz		55	62	_	dB
	663.34 697.66	MHz		55 ²⁾	58	_	dB
	663.34 697.66	MHz		50	58	_	dB
	1326 1396	MHz		30	61	_	dB
	1989 2094	MHz		30	57	_	dB
	2652 2792	MHz		30	54	_	dB

See Sec. Matching circuit (p. 6).

²⁾ Valid for temperature T = 0 °C...+85 °C.



7 **Maximum ratings**

Storage temperature	T _{STG} ²⁾ = −40 °C +85 °C	
DC voltage	$ V_{DC} ^{1)} = 0 \text{ V (max.)}$	
ESD voltage		
	$V_{\rm ESD}^{3)} = 200 \rm V (max.)$	Machine model.
	$V_{\rm ESD}^{4)} = 500 \rm V (max.)$	Human body model.
	$V_{\rm ESD}^{5)} = 700 \rm V (max.)$	Charged device model.
Input power	P _{IN}	
@ TX port: 663.34 697.66 MHz	29 dBm (max.)	5 MHz LTE uplink signal (25 RB) for 5000 h @ 50 °C.
@ TX port: 663.34 697.66 MHz	30 dBm (max.)	5 MHz LTE uplink signal (25 RB) for 2000 h @ 50 °C.
@ TX port: other frequency ranges	10 dBm (max.)	Continuous wave for 5000 h @ 50 °C.

¹⁾ In case of applied DC voltage blocking capacitors are mandatory.

Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

³⁾ According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse.

According to JESD22-C101C (CDM – Field Induced Charged Device Model), 3 negative & 3 positive pulses.

8 Transmission coefficients

8.1 TX - ANT 0.0 1.0 1.413 2.0 l.946 3.0 4.0 5.0 670 680 690 700 660 $f/{\sf MHz}$ 0.0 20.0 40.0 60.0 80.0 <u>+</u> 500 700 550 600 750 800 650 *f*/MHz 0.0 20.0 40.0 60.0 0.08 1000 2000 3000 4000 5000 6000 f/MHz

Figure 3: Attenuation TX – ANT.

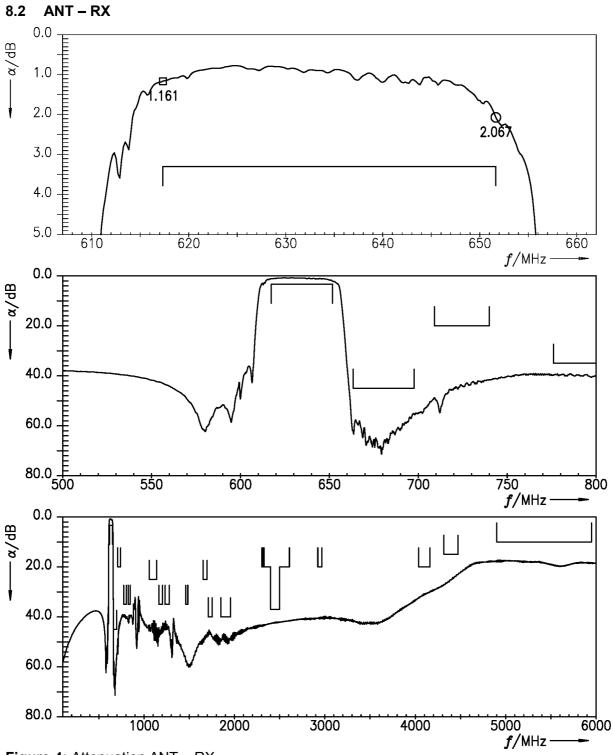


Figure 4: Attenuation ANT – RX.

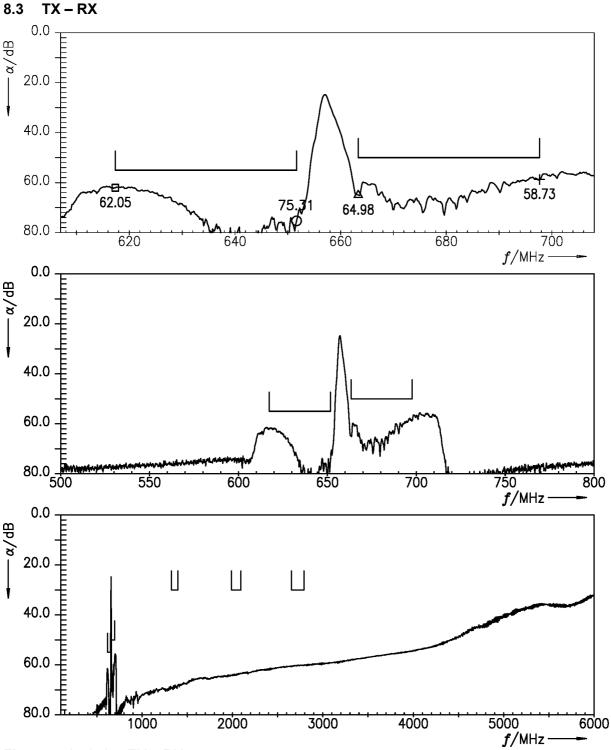
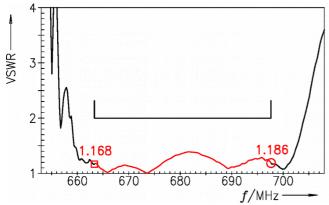


Figure 5: Isolation TX – RX.

9 Reflection coefficients



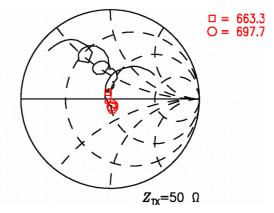
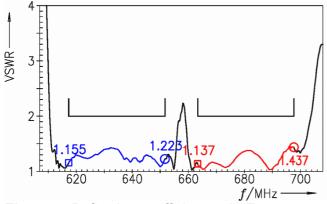


Figure 6: Reflection coefficient at TX port.



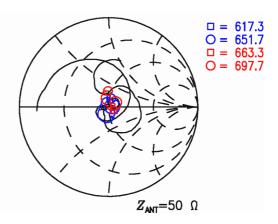
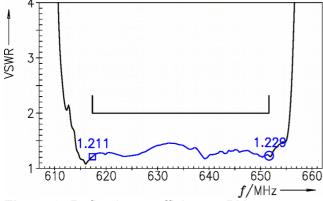


Figure 7: Reflection coefficient at ANT port.



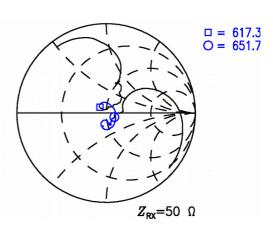
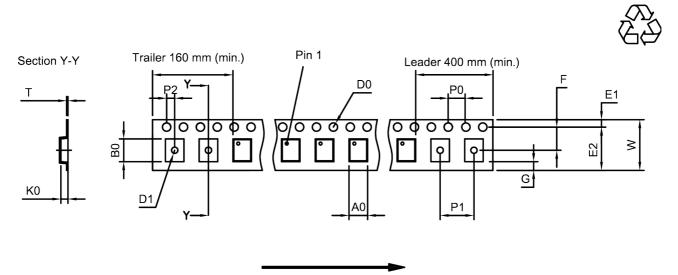


Figure 8: Reflection coefficient at RX port.

10 Packing material

10.1 Tape



User direction of unreeling

Figure 9: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A_0	2.3±0.05 mm	E ₂	6.25 mm (min.)	P_1	4.0±0.1 mm
B ₀	2.8±0.05 mm	F	3.5±0.05 mm	 P_2	2.0±0.05 mm
D ₀	1.5+0.1/-0 mm	G	0.75 mm (min.)	Т	0.25±0.03 mm
D_1	1.0 mm (min.)	K_0	0.85±0.05 mm	W	8.0+0.3/-0.1 mm
E ₁	1.75±0.1 mm	P ₀	4.0±0.1 mm		

Table 1: Tape dimensions.

10.2 Reel with diameter of 180 mm

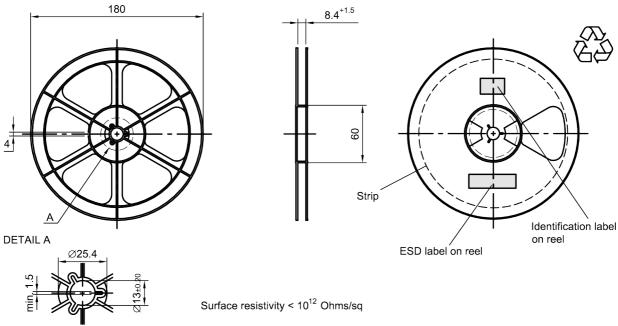


Figure 10: Drawing of reel (first-angle projection) with diameter of 180 mm.

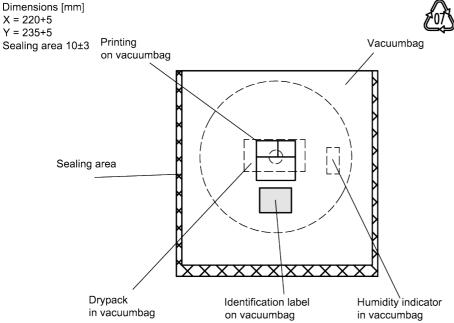


Figure 11: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

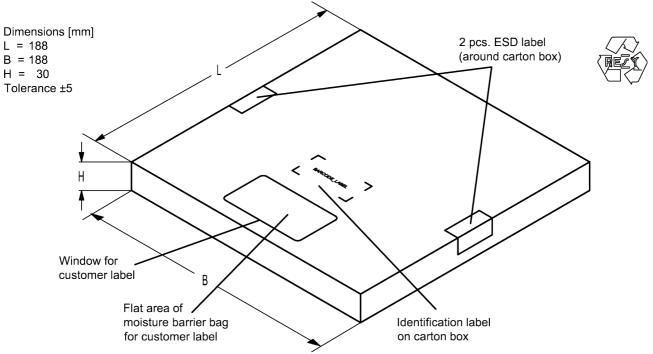


Figure 12: Drawing of folding box for reel with diameter of 180 mm.

10.3 Reel with diameter of 330 mm

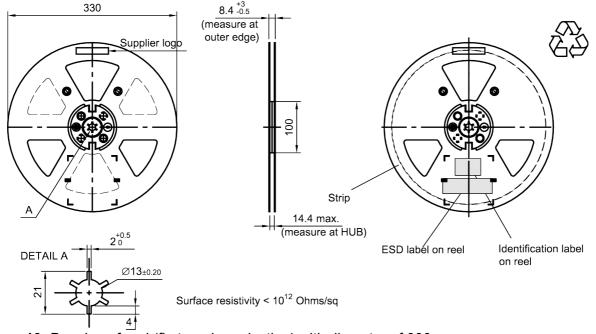


Figure 13: Drawing of reel (first-angle projection) with diameter of 330 mm.

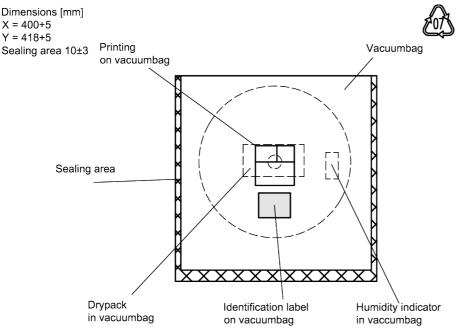


Figure 14: Drawing of moisture barrier bag (MBB) for reel with diameter of 330 mm.

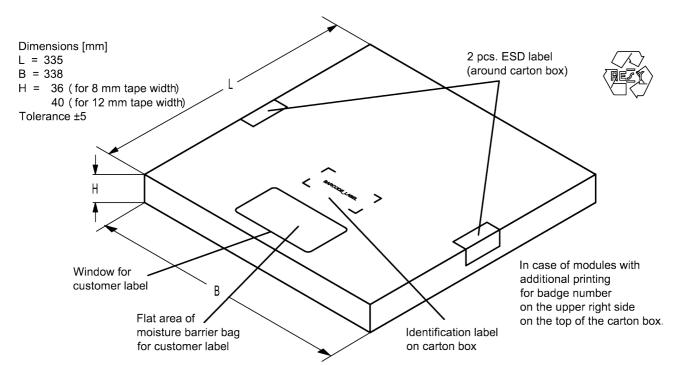


Figure 15: Drawing of folding box for reel with diameter of 330 mm.

11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB**1234**xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

16J => 1234 1 x 32^2 + 6 x 32^1 + 18 (=J) x 32^0 = 1234

The BASE32 code for product type B1237 is 16N.

■ Lot number:

The last 5 digits of the lot number, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

5UY => 12345 $5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0 =$ 12345

Adopte	Adopted BASE32 code for type number					
Decimal	Base32	Decimal	Base32			
value	code	value	code			
0	0	16	G			
1	1	17	Н			
2	2	18	J			
3	3	19	K			
4	4	20	M			
5	5	21	N			
6	6	22	Р			
7	7	23	Q			
8	8	24	R			
9	9	25	S			
10	Α	26	Т			
11	В	27	V			
12	С	28	W			
13	D	29	Х			
14	E	30	Y			
15	F	31	Z			

Adopted BASE47 code for lot number					
Decimal	Base47	Decimal	Base47		
value	code	value	code		
0	0	24	R		
1	1	25	S		
2	2	26	Т		
3	3	27	U		
4	4	28	V		
5	5	29	W		
6	6	30	X		
7	7	31	Y		
8	8	32	Z		
9	9	33	b		
10	Α	34	d		
11	В	35	f		
12	С	36	h		
13	D	37	n		
14	E	38	r		
15	F	39	t		
16	G	40	V		
17	Н	41	\		
18	J	42	?		
19	K	43	{		
20	L	44	}		
21	M	45	<		
22	N	46	>		
23	Р				

Table 2: Lists for encoding and decoding of marking.

12 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T _{peak}	250 °C +0/-5 °C
wetting temperature T _{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

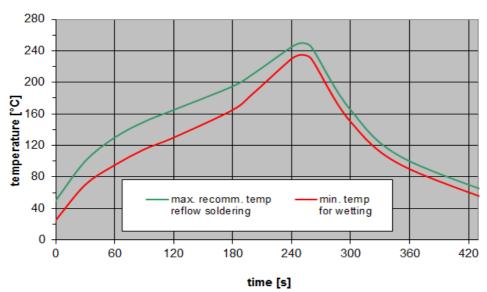


Figure 16: Recommended reflow profile for convection and infrared soldering – lead-free solder.



13 Annotations

13.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

13.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

13.4 Ordering codes and packing units

Ordering code	Packing unit
B39661B1237L210	15000 pcs
B39661B1237L210S 5	5000 pcs

Table 4: Ordering codes and packing units.



14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.



15 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
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